



WANSEMI
万芯半导体

WP2318

Enhancement Mode N-Channel Power MOSFET

SOT23/NMOS/40V/±20V/1.2V/5A/29mΩ

Rev1.0

40V, 29mΩ, 5A, N-Channel MOSFET

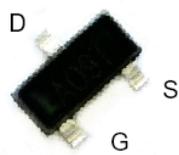
1.Features

- ◆ Advanced Trench Technology
- ◆ Surface mount package

2.Applications

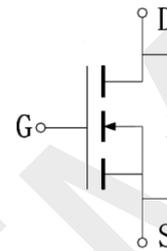
- ◆ Power Management
- ◆ Load Switching

V_{DS}	$R_{DS(on)}$ Typ.	I_D
40V	29mΩ @ 10V	5A
	36mΩ @ 4.5V	



SOT23

Pin Description



Schematic Diagram

3.Package Marking and Ordering Information

Part no.	Marking	Package	PCS/Reel	PCS/CTN.
WP2318	*	SOT23	3,000	180,000

4.Absolute Max Ratings at Ta=25°C (Note1)

Parameter	Symbol	Maximum	Units
Drain to Source Voltage	V_{DSS}	40	V
Gate to Source Voltage	V_{GSS}	±20	V
Drain Current (DC)	I_D	5	A
Drain Current (Pulse), $PW \leq 300\mu s$	I_{DP}	20	A
Total Dissipation	P_D	1.56	W
Thermal Resistance Junction-Ambient	$R_{\theta JA}$	80	°C/W
Junction Temperature	T_J	150	°C
Storage Temperature	T_{stg}	-55 to +150	°C

Note 1: Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

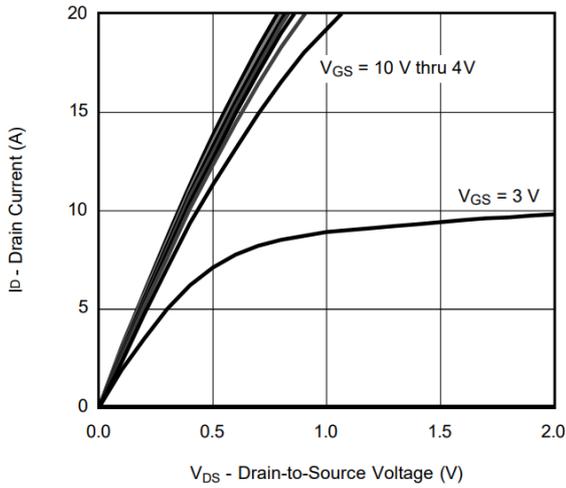
5. Electrical Characteristics at Ta=25°C (Note 2)

Parameter	Symbol	Test Conditions	Min.	Typ.	Max.	Units
Drain to Source Breakdown Voltage	$V_{(BR)DSS}$	$I_D = 250\mu A, V_{GS} = 0V$	40	-	-	V
Zero-Gate Voltage Drain Current	I_{DSS}	$V_{DS} = 40V, V_{GS} = 0V$	-	-	1	μA
Gate to Source Leakage Current	I_{GSS}	$V_{GS} = \pm 20V, V_{DS} = 0V$	-	-	± 100	nA
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS}=V_{GS}, I_{DS}=250\mu A$	0.7	1.2	2.0	V
Static Drain to Source On-State Resistance	$R_{DS(on)}$	$I_D = 5A, V_{GS} = 10V$	-	29	38	m Ω
		$I_D = 4A, V_{GS} = 4.5V$	-	36	52	m Ω
Input Capacitance	C_{iss}	$V_{GS}=0V,$ $V_{DS}=20V,$ Frequency=1.0MHz	-	340	-	pF
Output Capacitance	C_{oss}		-	60	-	pF
Reverse Transfer Capacitance	C_{rss}		-	30	-	pF
Turn-ON Delay Time	$t_{d(on)}$	$V_{DD} = 20V, I_D = 3.5A,$ $R_G = 1\Omega, V_{GS} = 4.5V$	-	4.1	-	ns
Rise Time	t_r		-	11.6	-	ns
Turn-OFF Delay Time	$t_{d(off)}$		-	24	-	ns
Fall Time	t_f		-	7.6	-	ns
Total Gate Charge	Q_g	$V_{DS} = 20V,$ $V_{GS} = 10V,$ $I_D = 5A$	-	5.8	-	nC
	Q_{gs}		-	0.4	-	nC
	Q_{gd}		-	2	-	nC
Diode Forward Voltage	V_{FSD}	$I_{SD} = 5A, V_{GS} = 0$	0.5	0.86	1.2	V

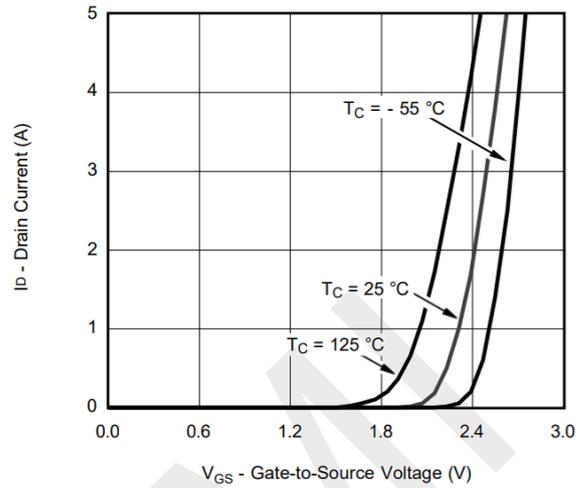
Note 2: Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.



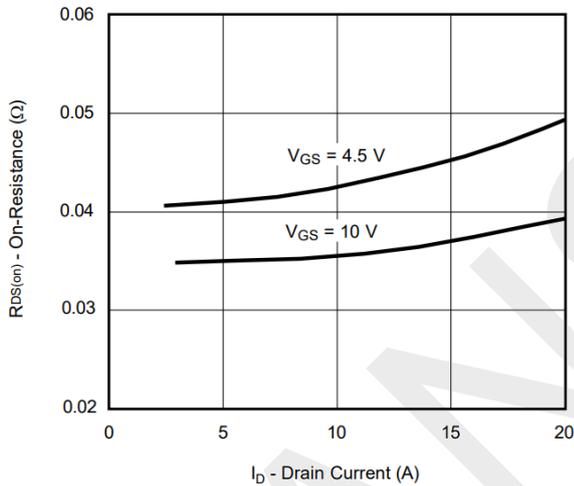
6. Typical Electrical and Thermal Characteristics



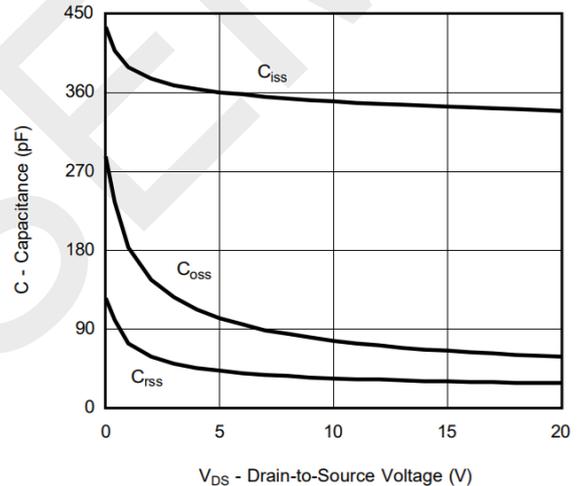
Output Characteristics



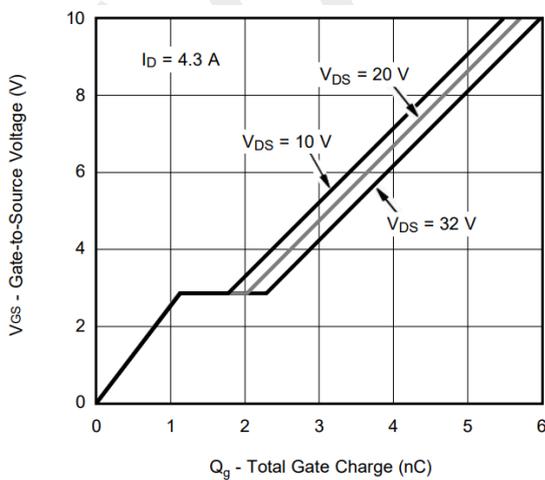
Transfer Characteristics



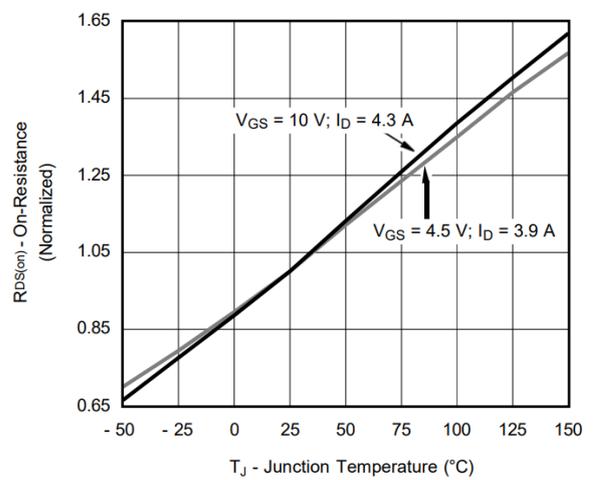
On-Resistance vs. Drain Current and Gate Voltage



Capacitance Characteristics



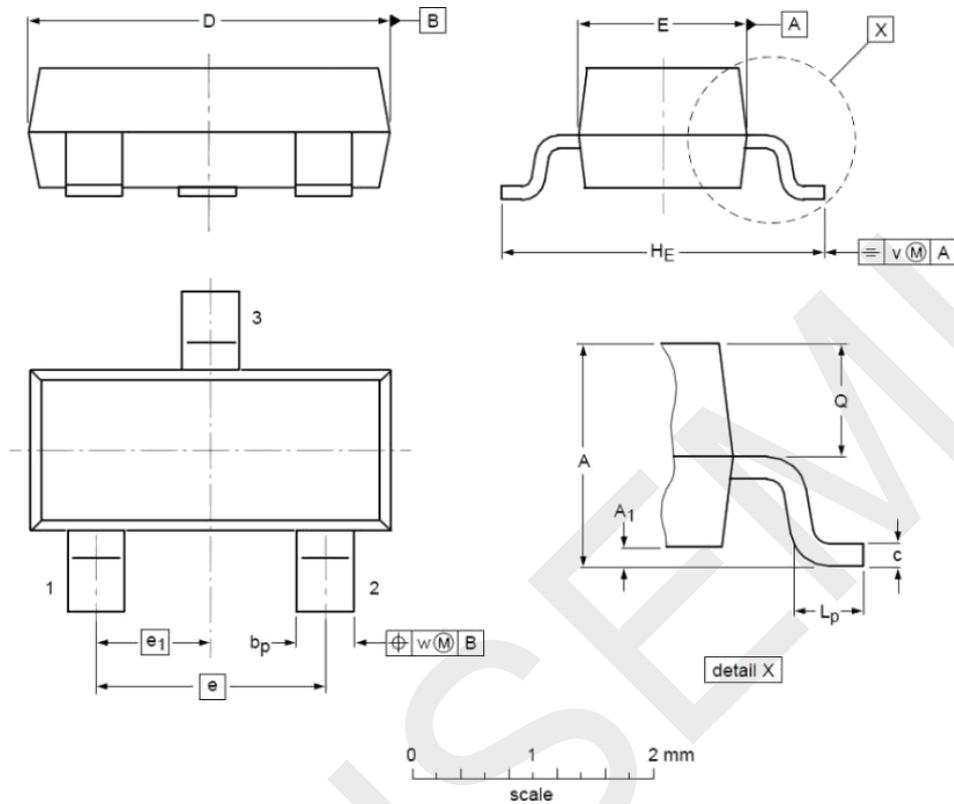
Gate Charge



On-Resistance vs. Junction Temperature



7.Package Dimensions



DIMENSIONS (unit : mm)

Symbol	Min	Typ	Max	Symbol	Min	Typ	Max
A	0.90	1.01	1.15	A ₁	0.01	0.05	0.10
b _p	0.30	0.42	0.50	c	0.08	0.13	0.15
D	2.80	2.92	3.00	E	1.20	1.33	1.40
e	--	1.90	--	e ₁	--	0.95	--
H _E	2.25	2.40	2.55	L _p	0.30	0.42	0.50
Q	0.45	0.49	0.55	v	--	0.20	--
w	--	0.10	--				

8.Important Notice

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